

Diode Lasers, 0.5 to 4.0 W, 8xx nm

2300 Series



Key Features

- 0.5, 1.2, 2.0 and 4.0 W CW power
- 50, 100, 200 and 500 μm apertures
- High-efficiency MOCVD quantum well design
- Open heatsink package
- High reliability

Applications

- Solid-state laser pumping
- Medical/ophthalmic applications
- Free-space communication
- Beacons/illumination

The 2300 series diode lasers offer high continuous wave (CW) optical power and high brightness with unsurpassed reliability. The small emitting aperture, combined with low beam divergence, makes the 2300 series one of the highest-brightness CW diode lasers available in the industry today.

The 2300 series consists of partially coherent broad-area emitters with relatively uniform emission over the emitting aperture. Operation is multi longitudinal mode with a spectral envelope width of approximately 2 nm FWHM. The far field beam divergence in the plane perpendicular to the P/N junction is nearly Gaussian, while the lateral beam profile exhibits a multiple-transverse mode pattern typical of broad-area emitters. Emitting apertures for 2300 variants range from 50 to 500 μm , giving CW power output capability of up to 4 W with superlative reliability. For higher-power 100 and 200 μm aperture devices, JDSU's 2400 Series diode lasers are ideal.

The high efficiency of the quantum well structure, combined with low thermal resistance epi-down chip mounting, provides minimum junction temperature at high optical power. Low junction temperature and low thermal resistance packages extend lifetime and increase reliability.

These diodes come mounted on conventional open heatsink packages that allow easy integration into user systems.

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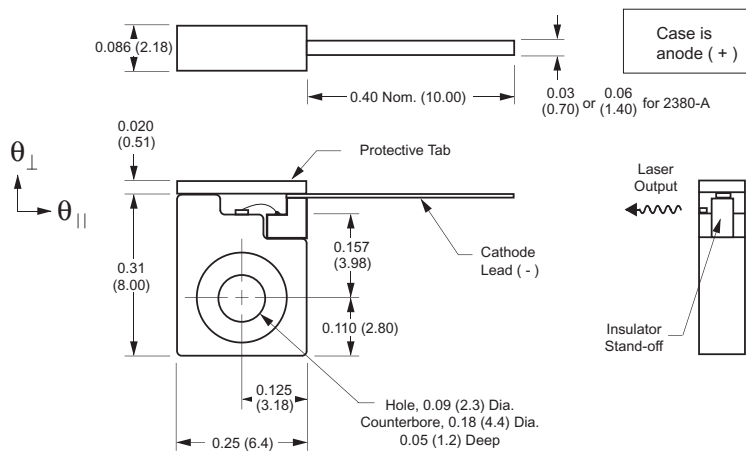
Dimensions Diagram

(Specifications in inches [mm] unless otherwise noted.)

Standard Tolerances

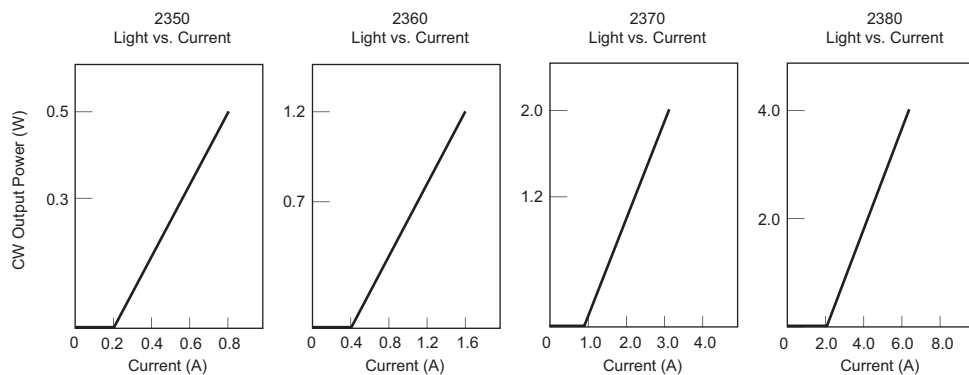
inches: $x.xx = \pm 0.02$ mm: $x.x = \pm 0.5$ $x.xxx = \pm 0.010$ $x.xx = \pm 0.25$

A-block Open Heatsink Package



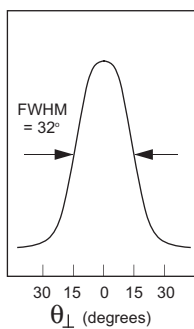
3

Typical Optical Characteristics

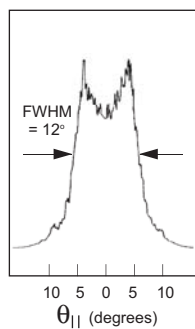


2350, 2360 and 2370 Laser Emission

Far Field Energy Distribution

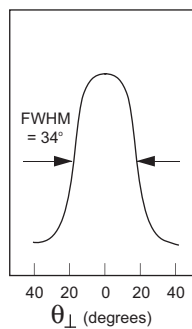


Far Field Energy Distribution

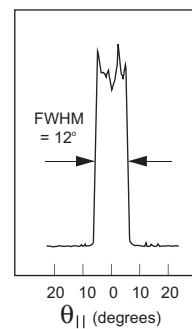


2380 Laser Emission

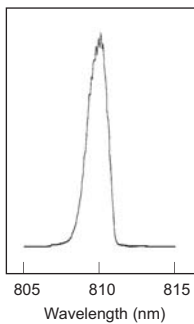
Far Field Energy Distribution



Far Field Energy Distribution



Typical Emission Spectrum



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Available Configurations	2350 Series 2350-A	2360 Series 2360-A	2370 Series 2370-A	2380 Series 2380-A
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Electro-optical Specifications

Parameter	Symbol	2350 Series			2360 Series			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
Laser Characteristics								
CW output power ²	P _O	—	—	0.5	—	—	1.2	W
Center wavelength	λ _c	—	(note ¹)	—	—	(note ¹)	—	nm
Spectral width	Δλ	—	2	—	—	2	—	nm
Slope efficiency	η _D = P _O /(I _{op} –I _{th})	0.7	0.9	—	0.7	0.9	—	W/A
Conversion efficiency	η = P _O /(I _{op} V _{op})	—	30	—	—	30	—	%
Emitting dimensions	W x H	—	50 x 1	—	—	100 x 1	—	μm
FWHM beam divergence								
Parallel to junction	θ _{//}	—	12	—	—	12	—	degrees
Perpendicular to junction	θ _⊥	—	32	—	—	32	—	degrees
Threshold current	I _{th}	—	0.2	0.25	—	0.4	0.6	A
Operating current	I _{op}	—	0.8	0.85	—	1.6	1.8	A
Operating voltage	V _{op}	—	(note ³)	—	—	(note ⁵)	—	
Series resistance	R _s	—	0.5	0.7	—	0.25	0.5	Ω
Thermal resistance	R _{th}	—	12	—	—	10	—	°C/W
Recommended case temperature	T _c	-20	—	30	-20	—	30	°C
Absolute Maximum Ratings								
Reverse voltage	V _{rl}	—	—	3	—	—	3	V
Case operating temperature	T _{op}	-20	—	50	-20	—	50	°C
Storage temperature range	T _{stg}	-40	—	80	-40	—	80	°C
Lead soldering temperature	T _{is}	—	—	250 (5 sec.)	—	—	250 (5 sec.)	°C

1. Consult table on page 6 for the particular wavelength ranges that are available.

2. Typical values at 25 °C and 0.6 NA collection optics.

3. Features common to these products include:

a. Duty factor of 100%.

b. Temperature coefficient of wavelength is approximately 0.27 to 0.3 nm/°C.

c. Temperature coefficient of threshold current can be modeled as:

$$I_{TH2} = I_{TH1} \exp [(T_2 - T_1)/T_0]$$

where T₀ is a device constant of about 160° K.

d. Temperature coefficient of operating current is approximately 1% per °C.

4. Modulation bandwidth of CW diode lasers is approximately 1 GHz though the effective rep rates are dependent on drive signals and use conditions.

5. Forward voltage is typically:

$$V_f = 1.5 \text{ V} + I_{OP} \times R_s$$

Electro-optical Specifications

Continued

Parameter	Symbol	2370 Series			2380 Series			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
Laser Characteristics								
CW output power ²	P _O	–	–	2	–	–	4	W
Center wavelength	λ _C	–	(note ¹)	–	–	(note ¹)	–	nm
Spectral width	Δλ	–	2	–	–	2	–	nm
Slope efficiency	η _D = P _O /(I _{op} –I _{th})	0.7	0.9	–	0.7	0.9	–	W/A
Conversion efficiency	η = P _O /(I _{op} V _{op})	–	30	–	–	30	–	%
Emitting dimensions (note ⁶)	W x H	–	200 x 1	–	–	500 x 1	–	μm
FWHM beam divergence								
Parallel to junction	θ _{//}	–	12	–	–	12	–	degrees
Perpendicular to junction	θ _⊥	–	32	–	–	32	–	degrees
Threshold current	I _{th}	–	0.9	1.2	–	2.0	2.5	A
Operating current	I _{op}	–	3.1	3.4	–	6.3	6.8	A
Operating voltage	V _{op}	–	(note ⁵)	–	–	(note ⁵)	–	
Series resistance	R _s	–	0.12	0.2	–	0.08	0.1	Ω
Thermal resistance	R _{th}	–	8	–	–	4	–	°C/W
Recommended case temperature	T _C	-20	–	30	-20	–	30	°C
Absolute Maximum Ratings								
Reverse voltage	V _{rl}	–	–	3	–	–	3	V
Case operating temperature	T _{op}	-20	–	50	-20	–	50	°C
Storage temperature range	T _{stg}	-40	–	80	-40	–	80	°C
Lead soldering temperature	T _{js}	–	–	250 (5 sec.)	–	–	250 (5 sec.)	°C

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d. Temperature coefficient of operating current is approximately 1% per °C.

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5. Forward voltage is typically:

$$V_f = 1.5 \text{ V} + I_{OP} \times R_S$$

6. The 2380 series near field consists of two active segments separated by an isolation space to produce specified aperture.

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Ordering Information

For more information on this or other products and their availability, please contact your local JDSU account manager or JDSU directly at 1-800-498-JDSU (5378) in North America and +800-5378-JDSU worldwide or via e-mail at customer.service@jdsu.com.

Sample: 23-00379

Laser Chip: 50 μm Stripe

Package Style: "A-block" Open Heat Sink

Part Number	Wavelength	Power
23-00379	808 \pm 3 nm	0.5 W
23-00380	810 \pm 3 nm	0.5 W

Laser Chip: 100 μm Stripe

Package Style: "A-block" Open Heat Sink

Part Number	Wavelength	Power
23-00381	799 \pm 3 nm	1.2 W
23-00384	808 \pm 2 nm	1.2 W
23-00382	808 \pm 3 nm	1.2 W
23-00383	810 \pm 5 nm	1.2 W

Laser Chip: 200 μm Stripe

Package Style: "A-block" Open Heat Sink

Part Number	Wavelength	Power
23-00385	799 \pm 3 nm	2.0 W
23-00386	808 \pm 3 nm	2.0 W
23-00390	810 \pm 3 nm	1.0 W
23-00388	810 \pm 2.5 nm	1.4 W
23-00389	810 \pm 2 nm	2.0 W
23-00387	810 \pm 5 nm	2.0 W

Laser Chip: 500 μm Stripe

Package Style: "A-block" Open Heat Sink

Part Number	Wavelength	Power
23-00391	799 \pm 3 nm	4.0 W
23-00392	808 \pm 3 nm	4.0 W
23-00393	810 \pm 5 nm	4.0 W

User Safety

Safety and Operating Considerations

The laser light emitted from this diode laser is invisible and may be harmful to the human eye. Avoid looking directly into the diode laser or into the collimated beam along its optical axis when the device is in operation.

CAUTION: THE USE OF OPTICAL INSTRUMENTS WITH THIS PRODUCT WILL INCREASE EYE HAZARD.

Operating the diode laser outside of its maximum ratings may cause device failure or a safety hazard. Power supplies used with the component must be employed such that the maximum peak optical power cannot be exceeded.

CW diode lasers may be damaged by excessive drive current or switching transients. When using power supplies, connect the diode laser with the main power on and the output voltage at zero. The current should be increased slowly while the diode laser output power and the drive current are monitored.

Device degradation accelerates with increased temperature, and therefore careful attention to minimize the case temperature is advised. For example, life expectancy will decrease by a factor of four if the case is operated at 50 °C rather than 30 °C.

A proper heatsink for the diode laser on a thermal radiator will greatly enhance laser life. Firmly mount the laser on a radiator with a thermal impedance of less than 0.5 °C/W for increased reliability.

ESD PROTECTION – Electrostatic discharge is the primary cause of unexpected diode laser failure. Take extreme precaution to prevent ESD. Use wrist straps, grounded work surfaces and rigorous antistatic techniques when handling diode lasers.

Labeling

21 CFR 1040.10 Compliance

Because of the small size of these devices, each of the labels shown is attached to the individual shipping container. They are illustrated here to comply with 21 CFR 1040.10 as applicable under the Radiation Control for Health and Safety Act of 1968.

Serial Number Identification Label

JDS Uniphase Corporation	
MODEL:	S/N:
MANUFACTURED:	
WAVELENGTH:	1 op:
This laser product complies with 21 CFR 1040 as applicable	

Output Power Danger Labels



2350



2360, 2370, 2380

Package Aperture Labels



A-block Package Diodes